

Nuvo-5000LP Series

Intel® 6th-Gen Skylake Core™ i7/i5/i3 Fanless Controller with 6x GbE, MeziO™ Interface and Low-profile Chassis



CE FC

Key Features

- Intel® 6th Gen Core™ i7/i5/i3 LGA1151 35W/65W socket-type CPU
- MeziO™ interface for easy function expansion
- Rugged, -25°C to 70°C fanless operation
- Up to 6x GigE ports, supporting 9.5 KB jumbo frame
- Up to 32 GB, DDR4-2133 SODIMM
- One hot-swappable 2.5" HDD/SSD and one fixed 2.5" HDD/SSD, supporting RAID 0/1
- VGA/ DVI/ DP triple independent display, supporting 4K2K resolution
- 77 mm low-profile design

Introduction

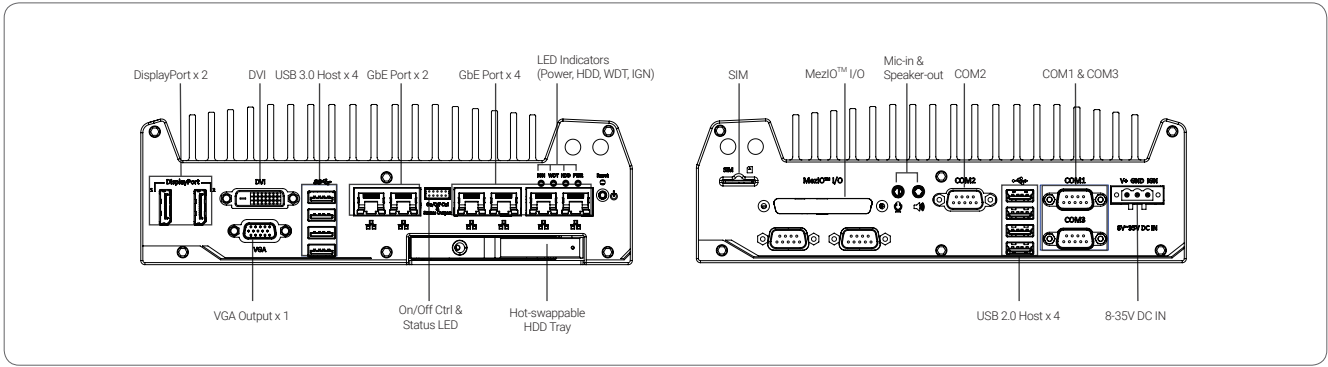
Nuvo-5002LP/5006LP is the low-profile version of Nuvo-5000 family. It features a low-profile chassis, which reduces its height to 77 mm, and remains extraordinary -25°C to 70°C operating temperature. For those demanding varied computing power, Nuvo-5002LP/5006LP supports socket-type CPU for flexible CPU installation. You can choose Intel® 6th Gen Core™ i7/i5/i3, from 35W to 65W TDP, according to your performance consideration and operating environment.

Nuvo-5002LP/5006LP inherits comprehensive I/O functions, such as GbE, USB3/USB2, COM and VGA/ DVI/ DP, from Nuvo-5000E/P. It also incorporates Neosys' MeziO™ interface for further I/O expansion. By installing optional MeziO™ module, Nuvo-5002LP/5006LP turns immediately from a typical embedded controller to a ruggedized application platform including 11x COM ports, 32 DIO channels, ignition power control, or your customized application-specific I/O.

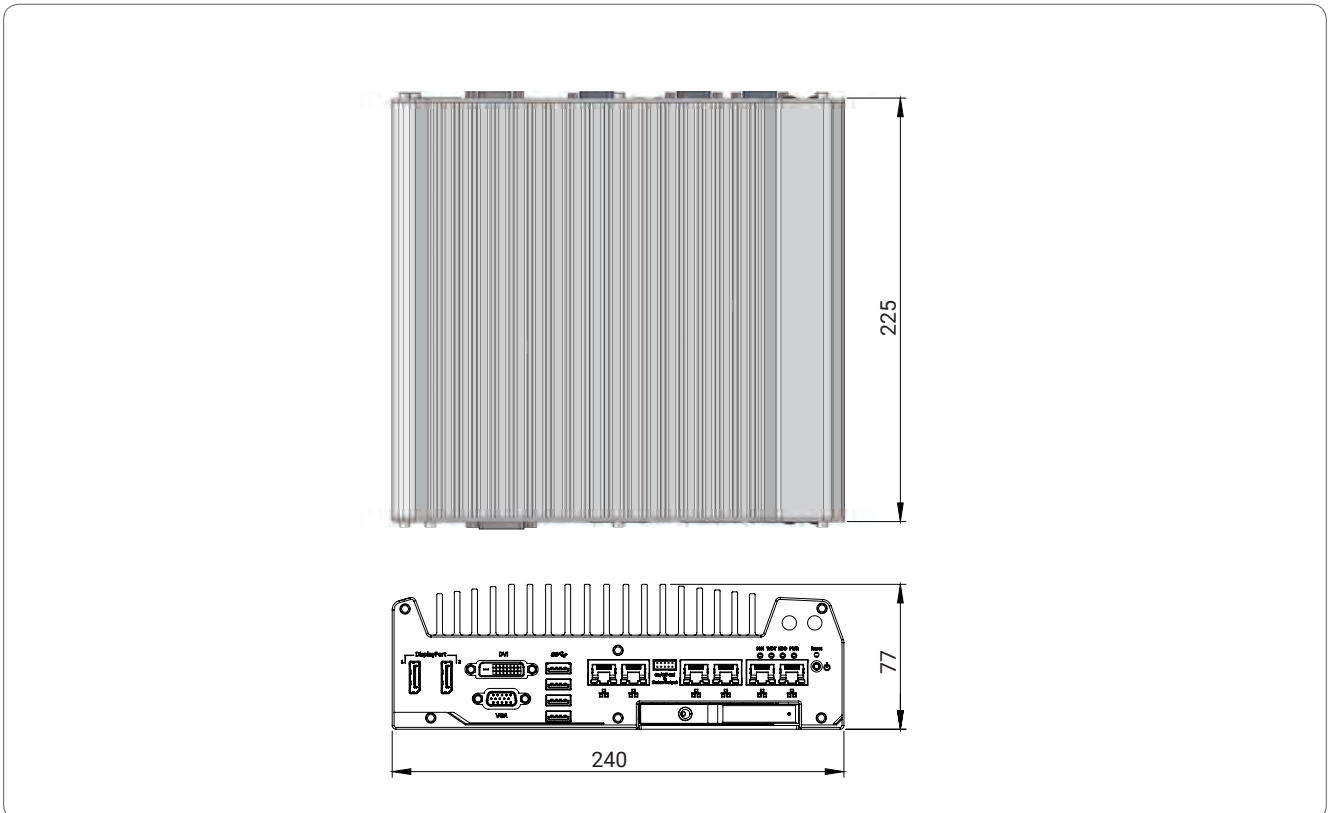
Specifications

System Core		Storage Interface	
Processor	Intel® Core™ i7-6700 (8M Cache, 3.4/4.0 GHz, 65W TDP)*	mSATA	1x full-size mSATA port (mux with mini-PCIe)
	Intel® Core™ i5-6500 (6M Cache, 3.2/3.6 GHz, 65W TDP)*	Expansion Bus	
	Intel® Core™ i3-6100 (3M Cache, 3.7 GHz, 51W TDP)*	Mini PCI-E	1x internal mini PCI Express socket with front-accessible SIM socket
	Intel® Pentium® G4400 (3M Cache, 3.3 GHz, 54W TDP)*		1x internal mini PCI Express socket with internal SIM socket (mux. with mSATA)
	Intel® Celeron® G3900 (2M Cache, 2.8 GHz, 51W TDP)*	Expandable I/O	1x MeziO™ expansion interface for Neosys MeziOTM modules
	Intel® Core™ i7-6700TE (8M Cache, 2.4/3.4 GHz, 35W TDP)	Power Supply	
	Intel® Core™ i5-6500TE (6M Cache, 2.3/3.3 GHz, 35W TDP)	DC Input	1x 3-pin pluggable terminal block for 8~35VDC DC input
	Intel® Core™ i3-6100TE (4M Cache, 2.7 GHz, 35W TDP)	Remote Ctrl. & Status Output	1x 10-pin (2x5) wafer connector for remote on/off control and status LED output
Intel® Pentium® G4400TE (3M Cache, 2.4 GHz, 35W TDP)	Mechanical		
Intel® Celeron® G3900TE (2M Cache, 2.3 GHz, 35W TDP)	Dimension	240 mm (W) x 225 mm (D) x 77mm (H)	
Chipset	Intel® Q170 Platform Controller Hub	Weight	3.1 kg (incl. CPU, memory and HDD)
Graphics	Integrated Intel® HD Graphics 530/510	Mounting	Wall-mounting by mounting bracket or optional DIN-Rail mounting
Memory	Up to 32 GB DDR4-2133 SDRAM by two SODIMM sockets	Environmental	
AMT	Supports AMT 11.0	Operating Temperature	with i7-6700TE, i5-6500TE, i3-6100TE, Pentium G4400TE (35W TDP) -25°C ~ 70°C **
TPM	Supports TPM 2.0		with i7-6700, i5-6500, i3-6100 (65W/51W TDP) -25°C ~ 70°C */** (configured as 35W CPU mode) -25°C ~ 50°C */** (configured as 65W/51W CPU mode)
I/O Interface		Storage Temperature	-40°C ~ 85°C
Ethernet	2x Gigabit Ethernet ports by Intel® I219 and I210 (Nuvo-5002LP) 6x Gigabit Ethernet ports by Intel® I219 and 5x I210 (Nuvo-5006LP)	Humidity	10%~90% , non-condensing
PoE+	Optional IEEE 802.3at PoE+ PSE for GbE Port 3 ~ Port 6, 80 W total power budget	Vibration	Operating, 5 Grms, 5-500 Hz, 3 Axes (w/ SSD, according to IEC60068-2-64)
USB	4x USB 3.0 ports via native XHCI controller 4x USB 2.0 ports	Shock	Operating, 50 Grms, Half-sine 11 ms Duration (w/ SSD, according to IEC60068-2-27)
Video Port	1x stacked VGA + DVI-D connector 2x DisplayPort connectors, supporting 4K2K resolution	EMC	CE/FCC Class A, according to EN 55022 & EN 55024
Serial Port	2x software-programmable RS-232/422/485 port (COM1 & COM2) 1x RS-232 port (COM3)	<p><small>For i7-6700 running at 65W mode, the high operating temperature shall be limited to 50°C and thermal throttling may occur when sustained full-loading applied. Users can configure CPU power in BIOS to obtain higher operating temperature.</small></p> <p><small>** For sub-zero operating temperature, a wide temperature HDD drive or Solid State Disk (SSD) is required.</small></p>	
Audio	1x Mic-in and 1x Speaker-out		
Storage Interface			
SATA HDD	1x hot-swappable HDD tray for 2.5" HDD/SSD installation 1x Internal SATA port for 2.5" HDD/SSD installation, supporting RAID 0/1		

Appearance



Dimensions



Ordering Information

Model No.

Intel® 6th-Gen Core™ fanless controller with 2x GbE, PCI Express Cassette and MeziO™

Nuvo-5006LP

Intel® 6th-Gen Core™ fanless controller with 2x GbE, PCI Cassette and MeziO™

Option of 802.3at PoE+ for GbE port 3 ~ port 6

Optional Accessories

DIN-Rail mounting kit

120W AC/DC power adapter

MeziO™ Modules

MeziO™-C180 MeziO™ module with 4x RS-232/422/485 ports and 4x RS-232 ports

MeziO™-C181 MeziO™ module with 4x RS-232/422/485 ports and 4x RS-422/485 ports

MeziO™-D220 MeziO™ module with 8-CH isolated digital input and 8-CH isolated digital output

MeziO™-D230 MeziO™ module with 16-CH isolated digital input and 16-CH isolated digital output

MeziO™-V20 MeziO™ module with ignition power control function and 1x mini-PCIe socket for in-vehicle usage